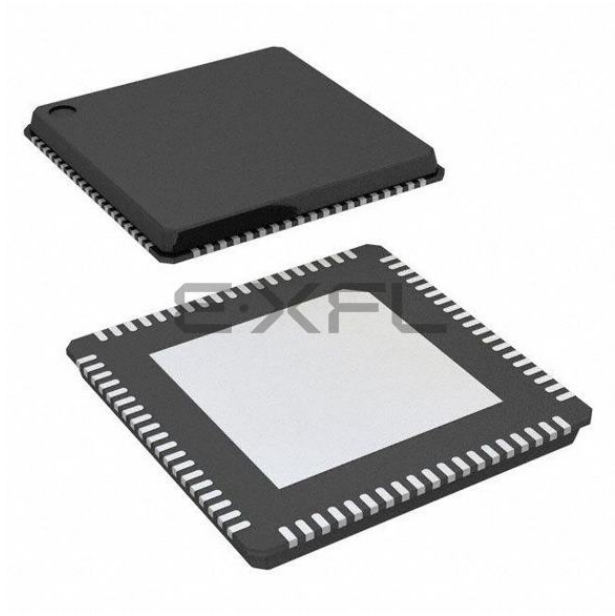


Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	FT32
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, Ethernet, I²C, SPI, UART/USART, USB
Peripherals	POR, PWM, WDT
Number of I/O	42
Program Memory Size	256KB (256K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	320K x 8
Voltage - Supply (Vcc/Vdd)	2.97V ~ 3.63V
Data Converters	A/D 4x10b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	76-VFQFN Exposed Pad
Supplier Device Package	76-QFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/bridgetek/ft905q-t

6. Pinning information

6.1 Pinning

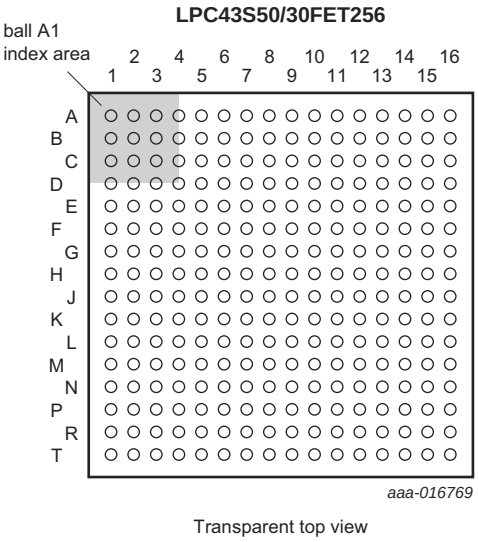


Fig 2. Pin configuration LBGA256 package

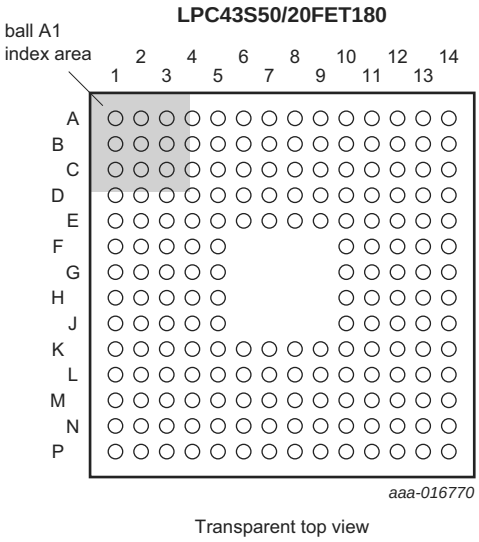


Fig 3. Pin configuration TFBGA180 package

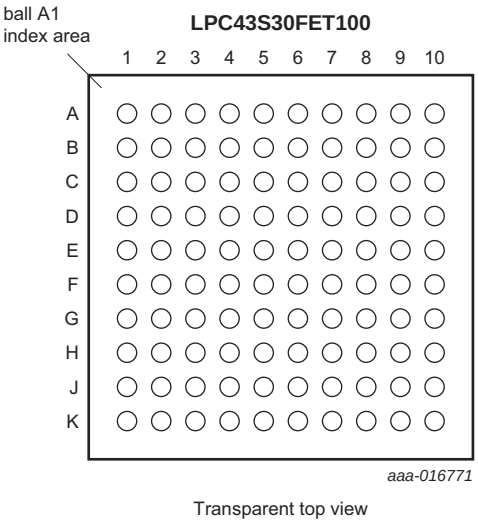


Fig 4. Pin configuration TFBGA100 package

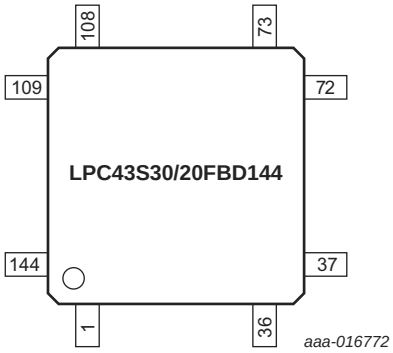


Fig 5. Pin configuration LQFP144 package

6.2 Pin description

On the LPC43S50/S30/S20, digital pins are grouped into 16 ports, named P0 to P9 and PA to PF, with up to 20 pins used per port. Each digital pin can support up to eight different digital functions, including General-Purpose I/O (GPIO), selectable through the System Configuration Unit (SCU) registers. The pin name is not indicative of the GPIO port assigned to it.

Table 3. Pin description

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
Multiplexed digital pins								
P0_0	L3	K3	G2	32	[2]	N; PU	I/O	**GPIO0[0] —** General purpose digital input/output pin.
							I/O	**SSP1_MISO —** Master In Slave Out for SSP1.
							I	**ENET_RXD1 —** Ethernet receive data 1 (RMII/MII interface).
							I/O	**SGPIO0 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**I2S0_TX_WS —** Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I²S-bus specification*.
							I/O	**I2S1_TX_WS —** Transmit Word Select. It is driven by the master and received by the slave. Corresponds to the signal WS in the *I²S-bus specification*.
P0_1	M2	K2	G1	34	[2]	N; PU	I/O	**GPIO0[1] —** General purpose digital input/output pin.
							I/O	**SSP1_MOSI —** Master Out Slave in for SSP1.
							I	**ENET_COL —** Ethernet Collision detect (MII interface).
							I/O	**SGPIO1 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
								ENET_TX_EN — Ethernet transmit enable (RMII/MII interface).
							I/O	**I2S1_TX_SDA —** I2S1 transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the *I²S-bus specification*.
P1_0	P2	L1	H1	38	[2]	N; PU	I/O	**GPIO0[4] —** General purpose digital input/output pin.
							I	**CTIN_3 —** SCTimer/PWM input 3. Capture input 1 of timer 1.
							I/O	**EMC_A5 —** External memory address line 5.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SSP0_SSEL —** Slave Select for SSP0.
							I/O	**SGPIO7 —** General purpose digital input/output pin.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P1_1	R2	N1	K2	42	[2]	N; PU	I/O	**GPIO0[8] —** General purpose digital input/output pin. Boot pin (see Table 5).
							O	**CTOUT_7 —** SCTimer/PWM output 7. Match output 3 of timer 1.
							I/O	**EMC_A6 —** External memory address line 6.
							I/O	**SGPIO8 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I/O	**SSP0_MISO —** Master In Slave Out for SSP0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P1_2	R3	N2	K1	43	[2]	N; PU	I/O	**GPIO0[9] —** General purpose digital input/output pin. Boot pin (see Table 5).
							O	**CTOUT_6 —** SCTimer/PWM output 6. Match output 2 of timer 1.
							I/O	**EMC_A7 —** External memory address line 7.
							I/O	**SGPIO9 —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I/O	**SSP0_MOSI —** Master Out Slave in for SSP0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P1_3	P5	M2	J1	44	[2]	N; PU	I/O	**GPIO0[10] —** General purpose digital input/output pin.
							O	**CTOUT_8 —** SCTimer/PWM output 8. Match output 0 of timer 2.
							I/O	**SGPIO10 —** General purpose digital input/output pin.
							O	**$\overline{\text{EMC\_OE}}$ —** LOW active Output Enable signal.
							O	**USB0_IND1 —** USB0 port indicator LED control output 1.
							I/O	**SSP1_MISO —** Master In Slave Out for SSP1.
							-	**R —** Function reserved.
							O	**SD_RST —** SD/MMC reset signal for MMC4.4 card.
P1_4	T3	P2	J2	47	[2]	N; PU	I/O	**GPIO0[11] —** General purpose digital input/output pin.
							O	**CTOUT_9 —** SCTimer/PWM output 9. Match output 3 of timer 3.
							I/O	**SGPIO11 —** General purpose digital input/output pin.
							O	**$\overline{\text{EMC\_BLS0}}$ —** LOW active Byte Lane select signal 0.
							O	**USB0_IND0 —** USB0 port indicator LED control output 0.
							I/O	**SSP1_MOSI —** Master Out Slave in for SSP1.
							-	**R —** Function reserved.
							O	**SD_VOLT1 —** SD/MMC bus voltage select output 1.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P2_8	J16	H14	C6	98	[2]	N; PU	I/O	**SGPIO15 —** General purpose digital input/output pin. Boot pin (see Table 5).
							O	**CTOUT_0 —** SCTimer/PWM output 0. Match output 0 of timer 0.
							I/O	**U3_DIR —** RS-485/EIA-485 output enable/direction control for USART3.
							I/O	**EMC_A8 —** External memory address line 8.
							I/O	**GPIO5[7] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_9	H16	G14	B10	102	[2]	N; PU	I/O	**GPIO1[10] —** General purpose digital input/output pin. Boot pin (see Table 5.
							O	**CTOUT_3 —** SCTimer/PWM output 3. Match output 3 of timer 0.
							I/O	**U3_BAUD —** Baud pin for USART3.
							I/O	**EMC_A0 —** External memory address line 0.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_10	G16	F14	E8	104	[2]	N; PU	I/O	**GPIO0[14] —** General purpose digital input/output pin.
							O	**CTOUT_2 —** SCTimer/PWM output 2. Match output 2 of timer 0.
							O	**U2_TXD —** Transmitter output for USART2.
							I/O	**EMC_A1 —** External memory address line 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
P2_11	F16	E13	A9	105	[2]	N; PU	I/O	**GPIO1[11] —** General purpose digital input/output pin.
							O	**CTOUT_5 —** SCTimer/PWM output 5. Match output 3 of timer 3.
							I	**U2_RXD —** Receiver input for USART2.
							I/O	**EMC_A2 —** External memory address line 2.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P4_5	D2	C2	-	10	[2]	N; PU	I/O	**GPIO2[5] —** General purpose digital input/output pin.
							O	**CTOUT_5 —** SCTimer/PWM output 5. Match output 3 of timer 3.
							O	**LCD_FP —** Frame pulse (STN). Vertical synchronization pulse (TFT).
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO11 —** General purpose digital input/output pin.
P4_6	C1	B1	-	11	[2]	N; PU	I/O	**GPIO2[6] —** General purpose digital input/output pin.
							O	**CTOUT_4 —** SCTimer/PWM output 4. Match output 3 of timer 3.
							O	**LCD_ENAB/LCDM —** STN AC bias drive or TFT data enable input.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SGPIO12 —** General purpose digital input/output pin.
P4_7	H4	F4	-	14	[2]	O; PU	O	**LCD_DCLK —** LCD panel clock.
							I	**GP_CLKIN —** General-purpose clock input to the CGU.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**I2S1_TX_SCK —** Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I^2S-bus specification.
							I/O	**I2S0_TX_SCK —** Transmit Clock. It is driven by the master and received by the slave. Corresponds to the signal SCK in the I^2S-bus specification.
P4_8	E2	D2	-	15	[2]	N; PU	-	**R —** Function reserved.
							I	**CTIN_5 —** SCTimer/PWM input 5. Capture input 2 of timer 2.
							O	**LCD_VD9 —** LCD data.
							-	**R —** Function reserved.
							I/O	**GPIO5[12] —** General purpose digital input/output pin.
							O	**LCD_VD22 —** LCD data.
							O	**CAN1_TD —** CAN1 transmitter output.
							I/O	**SGPIO13 —** General purpose digital input/output pin.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
P9_2	N8	M6	-	-	[2]	N; PU	I/O	**GPIO4[14] —** General purpose digital input/output pin.
							O	**MCOB2 —** Motor control PWM channel 2, output B.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**I2S0_TX_SDA —** I2S transmit data. It is driven by the transmitter and read by the receiver. Corresponds to the signal SD in the *I²S-bus specification*.
							I	**ENET_RXD3 —** Ethernet receive data 3 (MII interface).
							I/O	**SGPIO2 —** General purpose digital input/output pin.
							I/O	**SSP0_MOSI —** Master Out Slave in for SSP0.
P9_3	M6	P5	-	-	[2]	N; PU	I/O	**GPIO4[15] —** General purpose digital input/output pin.
							O	**MCOA0 —** Motor control PWM channel 0, output A.
							O	**USB1_IND1 —** USB1 Port indicator LED control output 1.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I	**ENET_RXD2 —** Ethernet receive data 2 (MII interface).
							I/O	**SGPIO9 —** General purpose digital input/output pin.
							O	**U3_TXD —** Transmitter output for USART3.
P9_4	N10	M8	-	-	[2]	N; PU	-	**R —** Function reserved.
							O	**MCOB0 —** Motor control PWM channel 0, output B.
							O	**USB1_IND0 —** USB1 Port indicator LED control output 0.
							-	**R —** Function reserved.
							I/O	**GPIO5[17] —** General purpose digital input/output pin.
							O	**ENET_TXD2 —** Ethernet transmit data 2 (MII interface).
							I/O	**SGPIO4 —** General purpose digital input/output pin.
							I	**U3_RXD —** Receiver input for USART3.
P9_5	M9	L7	-	69	[2]	N; PU	-	**R —** Function reserved.
							O	**MCOA1 —** Motor control PWM channel 1, output A.
							O	**USB1_PPWR —** VBUS drive signal (towards external charge pump or power management unit); indicates that VBUS must be driven (active high). Add a pull-down resistor to disable the power switch at reset. This signal has opposite polarity compared to the $\overline{\text{USB\_PPWR}}$ used on other NXP LPC parts.
							-	**R —** Function reserved.
							I/O	**GPIO5[18] —** General purpose digital input/output pin.
							O	**ENET_TXD3 —** Ethernet transmit data 3 (MII interface).
							I/O	**SGPIO3 —** General purpose digital input/output pin.
							O	**U0_TXD —** Transmitter output for USART0.

Table 3. Pin description *…continued*

LCD, Ethernet, USB0, and USB1 functions are not available on all parts. See Table 2.

Symbol	LBGA256	TFBGA180	TFBGA100	LQFP144		Reset state [1]	Type	Description
PB_6	A6	C5	-	-	[5]	N; PU	-	**R —** Function reserved.
							I/O	**USB1_ULPI_D3 —** ULPI link bidirectional data line 3.
							O	**LCD_VD13 —** LCD data.
							-	**R —** Function reserved.
							I/O	**GPIO5[26] —** General purpose digital input/output pin.
							I	**CTIN_6 —** SCTimer/PWM input 6. Capture input 1 of timer 3.
							O	**LCD_VD19 —** LCD data.
							-	**R —** Function reserved.
							AI	**ADC0_6 —** ADC0 and ADC1, input channel 6. Configure the pin as GPIO input and use the ADC function select register in the SCU to select the ADC.
PC_0	D4	-	-	-	[5]	N; PU	-	**R —** Function reserved.
							I	**USB1_ULPI_CLK —** ULPI link CLK signal. 60 MHz clock generated by the PHY.
							-	**R —** Function reserved.
							I/O	**ENET_RX_CLK —** Ethernet Receive Clock (MII interface).
							O	**LCD_DCLK —** LCD panel clock.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							I/O	**SD_CLK —** SD/MMC card clock.
							AI	**ADC1_1 —** ADC1 and ADC0, input channel 1. Configure the pin as input (USB_ULPI_CLK) and use the ADC function select register in the SCU to select the ADC.
PC_1	E4	-	-	-	[2]	N; PU	I/O	**USB1_ULPI_D7 —** ULPI link bidirectional data line 7.
							-	**R —** Function reserved.
							I	**U1_RI —** Ring Indicator input for UART 1.
							O	**ENET_MDC —** Ethernet MIIM clock.
							I/O	**GPIO6[0] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							I	**T3_CAP0 —** Capture input 0 of timer 3.
							O	**SD_VOLT0 —** SD/MMC bus voltage select output 0.
PC_2	F6	-	-	-	[2]	N; PU	I/O	**USB1_ULPI_D6 —** ULPI link bidirectional data line 6.
							-	**R —** Function reserved.
							I	**U1_CTS —** Clear to Send input for UART 1.
							O	**ENET_TXD2 —** Ethernet transmit data 2 (MII interface).
							I/O	**GPIO6[1] —** General purpose digital input/output pin.
							-	**R —** Function reserved.
							-	**R —** Function reserved.
							O	**SD_RST —** SD/MMC reset signal for MMC4.4 card.

7.5 AHB multilayer matrix

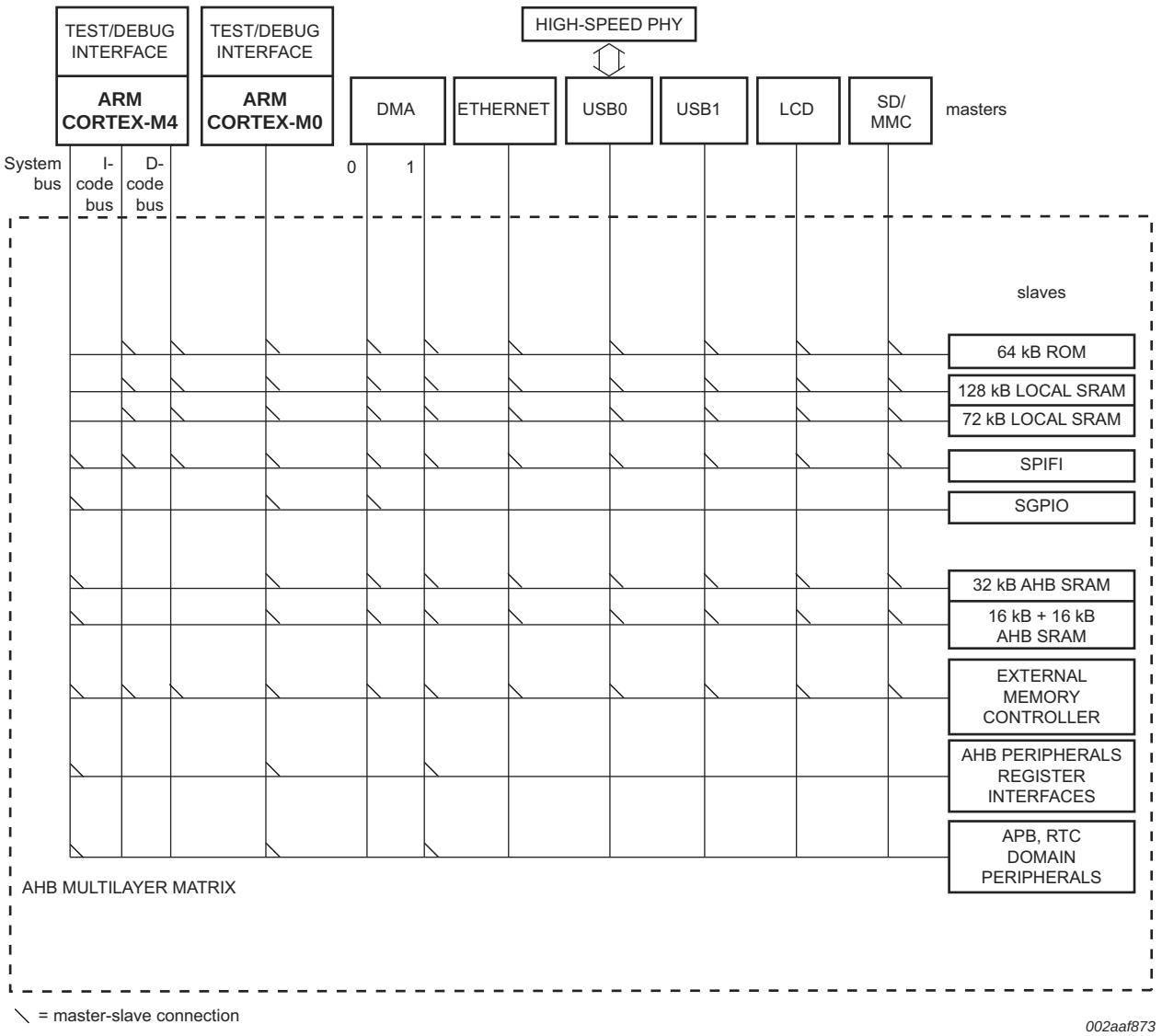


Fig 6. AHB multilayer matrix master and slave connections

7.6 Nested Vectored Interrupt Controller (NVIC)

The NVIC is an integral part of the Cortex-M4. The tight coupling to the CPU allows for low interrupt latency and efficient processing of late arriving interrupts.

The ARM Cortex-M0 coprocessor has its own NVIC with 32 vectored interrupts. Most peripheral interrupts are shared between the Cortex-M0 and Cortex-M4 NVICs.

7.14 One-Time Programmable (OTP) memory

The OTP provides 64 bit One-Time Programmable (OTP) memory for general-purpose use. 256 bit of OTP memory are available to store two AES keys in two memory banks. One bank is encrypted.

7.15 General-Purpose I/O (GPIO)

The LPC43S50/S30/S20 provide eight GPIO ports with up to 31 GPIO pins each.

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back as well as the current state of the port pins.

All GPIO pins default to inputs with pull-up resistors enabled and input buffer disabled on reset. The input buffer must be turned on in the system control block SFS register before the GPIO input can be read.

7.15.1 Features

- Accelerated GPIO functions:
  - GPIO registers are located on the AHB so that the fastest possible I/O timing can be achieved.
  - Mask registers allow treating sets of port bits as a group, leaving other bits unchanged.
  - All GPIO registers are byte and half-word addressable.
  - Entire port value can be written in one instruction.
- Bit-level set and clear registers allow a single instruction set or clear of any number of bits in one port.
- Direction control of individual bits.
- Up to eight GPIO pins can be selected from all GPIO pins to create an edge- or level-sensitive GPIO interrupt request (GPIO interrupts).
- Two GPIO group interrupts can be triggered by any pin or pins in each port (GPIO group0 and group1 interrupts).

7.16 Configurable digital peripherals

7.16.1 State Configurable Timer (SCTimer/PWM) subsystem

The SCTimer/PWM allows a wide variety of timing, counting, output modulation, and input capture operations. The inputs and outputs of the SCTimer/PWM are shared with the capture and match inputs/outputs of the 32-bit general-purpose counter/timers.

The SCTimer/PWM can be configured as two 16-bit counters or a unified 32-bit counter. In the two-counter case, in addition to the counter value the following operational elements are independent for each half:

- State variable
- Limit, halt, stop, and start conditions

- Optional forwarding of received pause control frames to the user application in full-duplex operation.
- Back-pressure support for half-duplex operation.
- Automatic transmission of zero-quanta pause frame on deassertion of flow control input in full-duplex operation.

- Supports IEEE1588 time stamping and IEEE 1588 advanced time stamping (IEEE 1588-2008 v2).

7.18 Digital serial peripherals

7.18.1 UART1

The LPC43S50/S30/S20 contain one UART with standard transmit and receive data lines. UART1 also provides a full modem control handshake interface and support for RS-485/9-bit mode allowing both software address detection and automatic address detection using 9-bit mode.

UART1 includes a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.18.1.1 Features

- Maximum UART data bit rate of 8 MBit/s.
- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.
- Built-in fractional baud rate generator covering wide range of baud rates without a need for external crystals of particular values.
- Auto baud capabilities and FIFO control mechanism that enables software flow control implementation.
- Equipped with standard modem interface signals. This module also provides full support for hardware flow control.
- Support for RS-485/9-bit/EIA-485 mode (UART1).
- DMA support.

7.18.2 USART0/2/3

The LPC43S50/S30/S20 contain three USARTs. In addition to standard transmit and receive data lines, the USARTs support a synchronous mode.

The USARTs include a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

7.18.2.1 Features

- Maximum UART data bit rate of 8 MBit/s.
- 16 B Receive and Transmit FIFOs.
- Register locations conform to 16C550 industry standard.
- Receiver FIFO trigger points at 1 B, 4 B, 8 B, and 14 B.

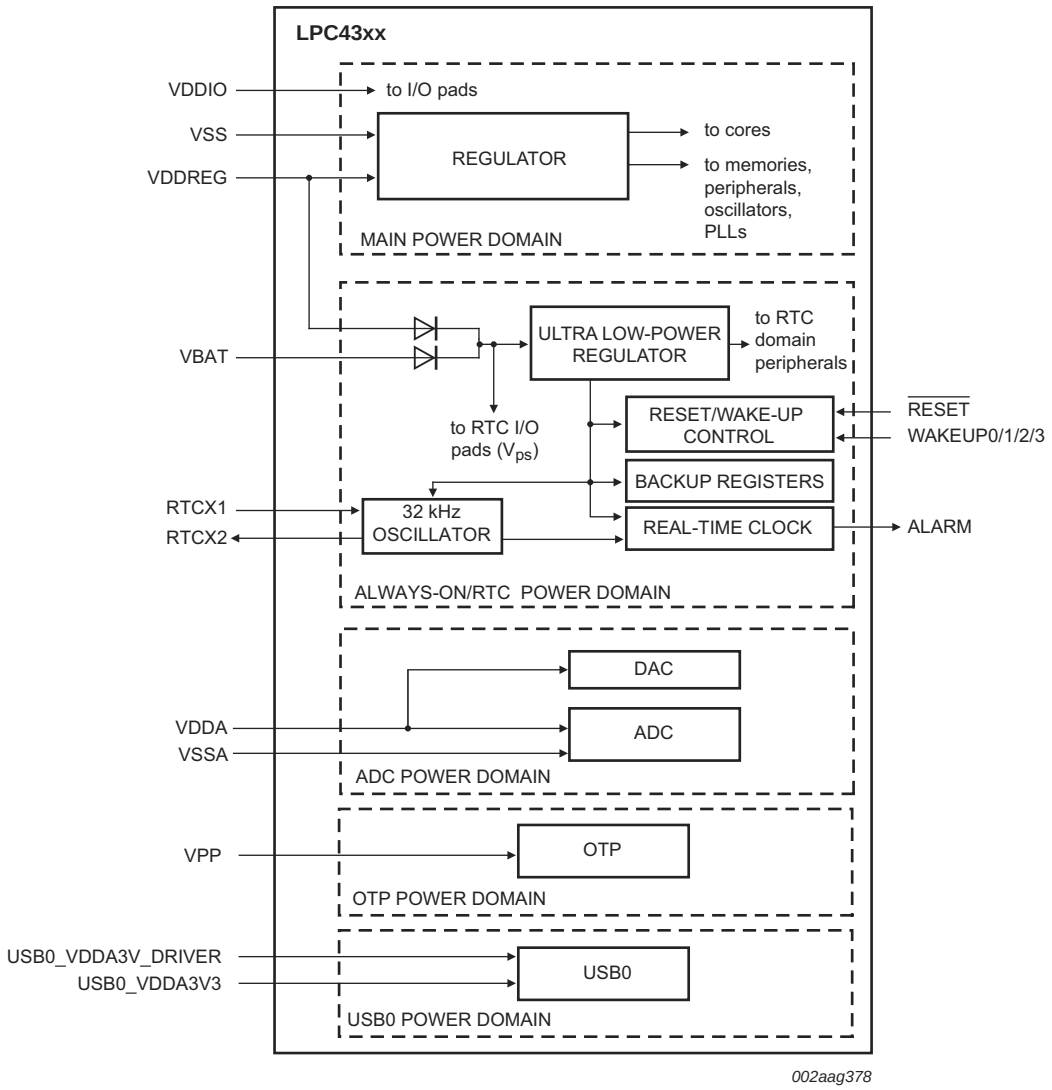


Fig 9. Power domains

7.22.10 Power Management Controller (PMC)

The PMC controls the power to the cores, peripherals, and memories.

The LPC43S50/S30/S20 support the following power modes in order from highest to lowest power consumption:

1. Active mode
2. Sleep mode
3. Power-down modes:
   a. Deep-sleep mode
   b. Power-down mode
   c. Deep power-down mode

10. Static characteristics

Table 10. Static characteristics

T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
Supply pins							
$V_{DD(IO)}$	input/output supply voltage			2.2	-	3.6	V
$V_{DD(REG)(3V3)}$	regulator supply voltage (3.3 V)		[2]	2.2	-	3.6	V
$V_{DDA(3V3)}$	analog supply voltage (3.3 V)	on pin VDDA		2.2	-	3.6	V
		on pins USB0_VDDA3V3_ DRIVER and USB0_VDDA3V3		3.0	3.3	3.6	V
V_{BAT}	battery supply voltage		[2]	2.2	-	3.6	V
$V_{prog(pf)}$	polyfuse programming voltage	on pin VPP (for OTP)	[3]	2.7	-	3.6	V
$I_{prog(pf)}$	polyfuse programming current	on pin VPP; OTP programming time ≤ 1.6 ms		-	-	30	mA
$I_{DD(REG)(3V3)}$	regulator supply current (3.3 V)	Active mode; M0-core in reset; code `while(1){}` executed from RAM; all peripherals disabled; PLL1 enabled					
		CCLK = 12 MHz	[4]	-	6.6	-	mA
		CCLK = 60 MHz	[4]		25.3	-	mA
		CCLK = 120 MHz	[4]	-	48.4	-	mA
		CCLK = 180 MHz	[4]	-	72.0	-	mA
		CCLK = 204 MHz	[4]	-	81.5	-	mA
$I_{DD(REG)(3V3)}$	regulator supply current (3.3 V)	after WFE/WFI instruction executed from RAM; all peripherals disabled; M0 core in reset					
		sleep mode	[4][5]	-	5.0	-	mA
		deep-sleep mode	[4]	-	30	-	µA
		power-down mode	[4]	-	15	-	µA
		deep power-down mode	[4][6]	-	0.03	-	µA
		deep power-down mode; VBAT floating	[4]-	-	2	-	µA
I_{BAT}	battery supply current	active mode; V_{BAT} = 3.2 V; $V_{DD(REG)(3V3)}$ = 3.6 V.	[7]	-	0	-	nA

Table 10. Static characteristics *…continued*
T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
I_{pu}	pull-up current	V_I = 0 V	[14][15][16]	-	−62	-	μA
		$V_{DD(IO)} < V_I \leq 5$ V		-	10	-	μA
I/O pins - high drive strength: standard drive mode							
I_{OH}	HIGH-level output current	$V_{OH} = V_{DD(IO)} - 0.4$ V		−4	-	-	mA
I_{OL}	LOW-level output current	V_{OL} = 0.4 V		4	-	-	mA
I_{OHS}	HIGH-level short-circuit output current	drive HIGH; connected to ground	[12]	-	-	32	mA
I_{OLS}	LOW-level short-circuit output current	drive LOW; connected to $V_{DD(IO)}$	[12]	-	-	32	mA
I/O pins - high drive strength: medium drive mode							
I_{OH}	HIGH-level output current	$V_{OH} = V_{DD(IO)} - 0.4$ V		−8	-	-	mA
I_{OL}	LOW-level output current	V_{OL} = 0.4 V		8	-	-	mA
I_{OHS}	HIGH-level short-circuit output current	drive HIGH; connected to ground	[12]	-	-	65	mA
I_{OLS}	LOW-level short-circuit output current	drive LOW; connected to $V_{DD(IO)}$	[12]	-	-	63	mA
I/O pins - high drive strength: high drive mode							
I_{OH}	HIGH-level output current	$V_{OH} = V_{DD(IO)} - 0.4$ V		−14	-	-	mA
I_{OL}	LOW-level output current	V_{OL} = 0.4 V		14	-	-	mA
I_{OHS}	HIGH-level short-circuit output current	drive HIGH; connected to ground	[12]	-	-	113	mA
I_{OLS}	LOW-level short-circuit output current	drive LOW; connected to $V_{DD(IO)}$	[12]	-	-	110	mA
I/O pins - high drive strength: ultra-high drive mode							
I_{OH}	HIGH-level output current	$V_{OH} = V_{DD(IO)} - 0.4$ V		−20	-	-	mA
I_{OL}	LOW-level output current	V_{OL} = 0.4 V		20	-	-	mA
I_{OHS}	HIGH-level short-circuit output current	drive HIGH; connected to ground	[12]	-	-	165	mA
I_{OLS}	LOW-level short-circuit output current	drive LOW; connected to $V_{DD(IO)}$	[12]	-	-	156	mA
I/O pins - high-speed							
C_I	input capacitance			-	-	2	pF
I_{LL}	LOW-level leakage current	V_I = 0 V; on-chip pull-up resistor disabled		-	3	-	nA

11.6 GPCLKIN

Table 19. Dynamic characteristic: GPCLKIN

T_{amb} = 25 °C; 2.4 V ≤ $V_{DD(REG)(3V3)}$ ≤ 3.6 V

Symbol	Parameter	Min	Typ	Max	Unit
GP_CLKIN	input frequency	-	-	25	MHz

11.7 I/O pins

Table 20. Dynamic characteristic: I/O pins[1]

T_{amb} = −40 °C to +85 °C; 2.7 V ≤ $V_{DD(IO)}$ ≤ 3.6 V.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Standard I/O pins - normal drive strength							
t_r	rise time	pin configured as output; EHS = 1	[2][3]	1.0	-	2.5	ns
t_f	fall time	pin configured as output; EHS = 1	[2][3]	0.9	-	2.5	ns
t_r	rise time	pin configured as output; EHS = 0	[2][3]	1.9	-	4.3	ns
t_f	fall time	pin configured as output; EHS = 0	[2][3]	1.9	-	4.0	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns
I/O pins - high drive strength							
t_r	rise time	pin configured as output; standard drive mode (EHD = 0x0)	[2][5]	4.3	-	7.9	ns
t_f	fall time	pin configured as output; standard drive mode (EHD = 0x0)	[2][5]	4.7	-	8.7	ns
t_r	rise time	pin configured as output; medium drive mode (EHD = 0x1)	[2][5]	3.2	-	5.7	ns
t_f	fall time	pin configured as output; medium drive mode (EHD = 0x1)	[2][5]	3.2	-	5.5	ns
t_r	rise time	pin configured as output; high drive mode (EHD = 0x2)	[2][5]	2.9	-	4.9	ns
t_f	fall time	pin configured as output; high drive mode (EHD = 0x2)	[2][5]	2.5	-	3.9	ns
t_r	rise time	pin configured as output; ultra-high drive mode (EHD = 0x3)	[2][5]	2.8	-	4.7	ns
t_f	fall time	pin configured as output; ultra-high drive mode (EHD = 0x3)	[2][5]	2.4	-	3.4	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns
I/O pins - high-speed							
t_r	rise time	pin configured as output; EHS = 1	[2][3]	350	-	670	ps
t_f	fall time	pin configured as output; EHS = 1	[2][3]	450	-	730	ps
t_r	rise time	pin configured as output; EHS = 0	[2][3]	1.0	-	1.9	ns
t_f	fall time	pin configured as output; EHS = 0	[2][3]	1.0	-	2.0	ns
t_r	rise time	pin configured as input	[4]	0.3	-	1.3	ns
t_f	fall time	pin configured as input	[4]	0.2	-	1.2	ns

[1] Simulated data.

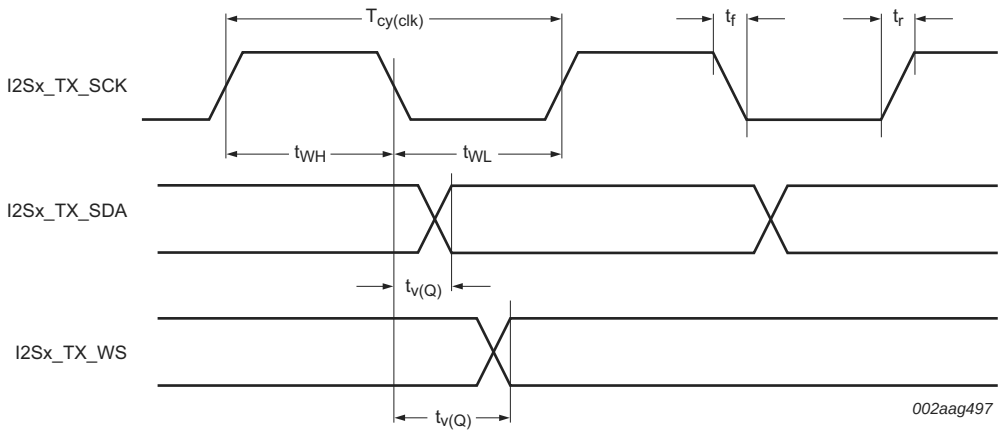


Fig 28. I²S-bus timing (transmit)

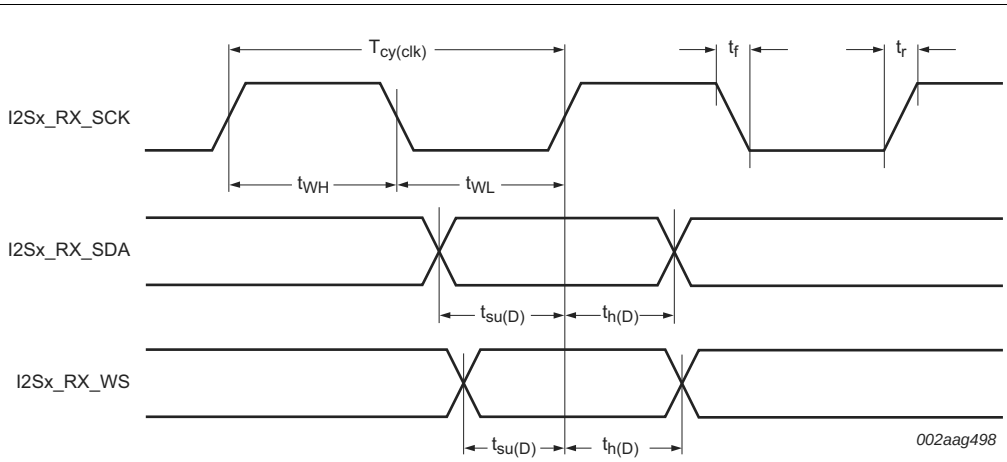


Fig 29. I²S-bus timing (receive)

11.10 USART interface

Table 23. USART dynamic characteristics

T_{amb} = −40 °C to 85 °C; 2.2 V ≤ $V_{DD(REG)(3V3)}$ ≤ 3.6 V; 2.7 V ≤ $V_{DD(IO)}$ ≤ 3.6 V; C_L = 20 pF. EHS = 1 for all pins. Simulated values.

Symbol	Parameter	Min	Max	Unit
USART master (in synchronous mode)				
$t_{su(D)}$	data input set-up time	26.6	-	ns
$t_{h(D)}$	data input hold time	0	-	ns
$t_{v(Q)}$	data output valid time	0	8.8	ns
USART slave (in synchronous mode)				
$t_{su(D)}$	data input set-up time	1.2	-	ns
$t_{h(D)}$	data input hold time	0.4	-	ns
$t_{v(Q)}$	data output valid time	5.5	24	ns

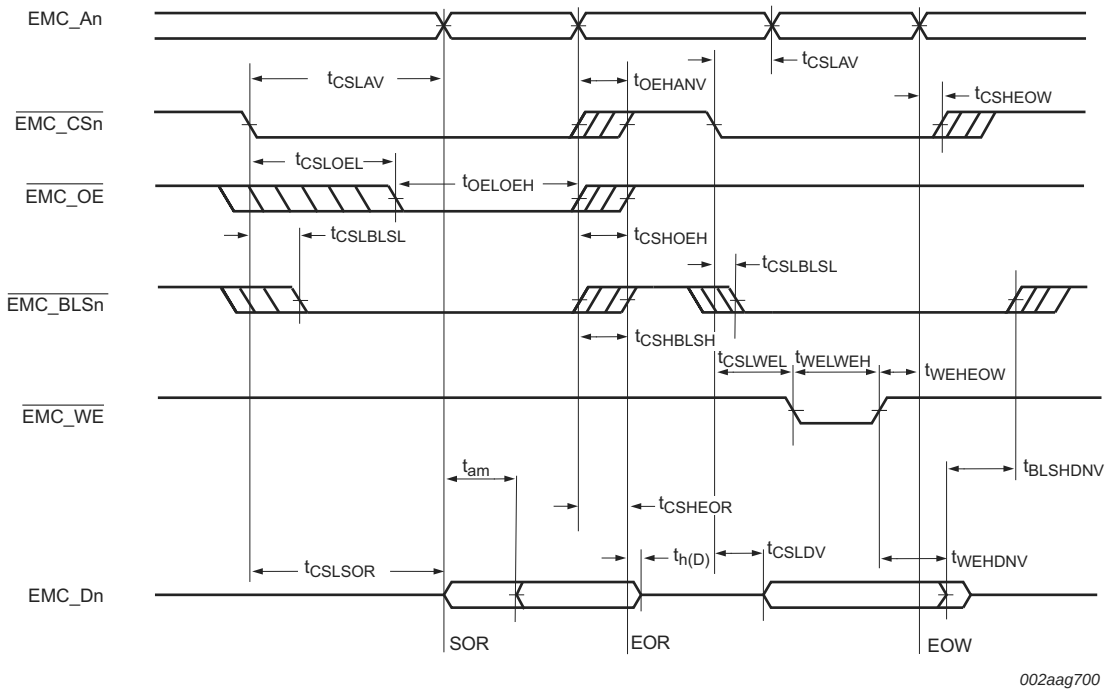


Fig 35. External static memory read/write access (PB = 1)

13. Application information

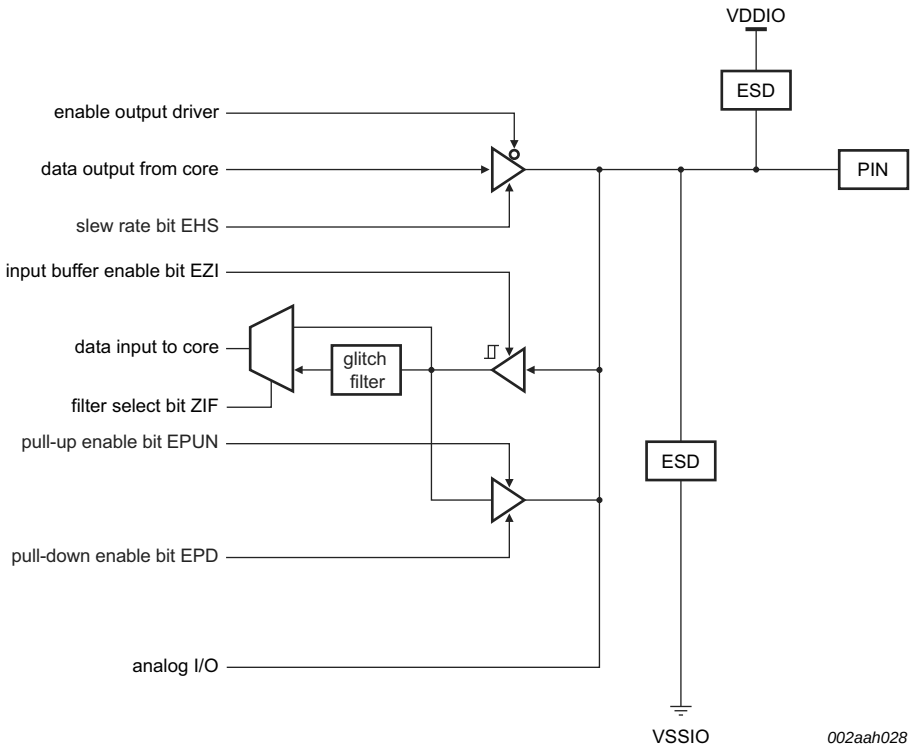
13.1 LCD panel signal usage

Table 38. LCD panel connections for STN single panel mode

External pin	4-bit mono STN single panel		8-bit mono STN single panel		Color STN single panel	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD[23:8]	-	-	-	-	-	-
LCD_VD7	-	-	P8_4	UD[7]	P8_4	UD[7]
LCD_VD6	-	-	P8_5	UD[6]	P8_5	UD[6]
LCD_VD5	-	-	P8_6	UD[5]	P8_6	UD[5]
LCD_VD4	-	-	P8_7	UD[4]	P8_7	UD[4]
LCD_VD3	P4_2	UD[3]	P4_2	UD[3]	P4_2	UD[3]
LCD_VD2	P4_3	UD[2]	P4_3	UD[2]	P4_3	UD[2]
LCD_VD1	P4_4	UD[1]	P4_4	UD[1]	P4_4	UD[1]
LCD_VD0	P4_1	UD[0]	P4_1	UD[0]	P4_1	UD[0]
LCD_LP	P7_6	LCDLP	P7_6	LCDLP	P7_6	LCDLP
LCD_ENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM	P4_6	LCDENAB/ LCDM
LCD_FP	P4_5	LCDFP	P4_5	LCDFP	P4_5	LCDFP
LCD_DCLK	P4_7	LCDDCLK	P4_7	LCDDCLK	P4_7	LCDDCLK
LCD_LE	P7_0	LCDLE	P7_0	LCDLE	P7_0	LCDLE
LCD_PWR	P7_7	CDPWR	P7_7	LCDPWR	P7_7	LCDPWR
GP_CLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN	PF_4	LCDCLKIN

Table 39. LCD panel connections for STN dual panel mode

External pin	4-bit mono STN dual panel		8-bit mono STN dual panel		Color STN dual panel	
	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function	LPC43xx pin used	LCD function
LCD_VD[23:16]	-	-	-	-	-	-
LCD_VD15	-	-	PB_4	LD[7]	PB_4	LD[7]
LCD_VD14	-	-	PB_5	LD[6]	PB_5	LD[6]
LCD_VD13	-	-	PB_6	LD[5]	PB_6	LD[5]
LCD_VD12	-	-	P8_3	LD[4]	P8_3	LD[4]
LCD_VD11	P4_9	LD[3]	P4_9	LD[3]	P4_9	LD[3]
LCD_VD10	P4_10	LD[2]	P4_10	LD[2]	P4_10	LD[2]
LCD_VD9	P4_8	LD[1]	P4_8	LD[1]	P4_8	LD[1]
LCD_VD8	P7_5	LD[0]	P7_5	LD[0]	P7_5	LD[0]
LCD_VD7	-	-		UD[7]	P8_4	UD[7]
LCD_VD6	-	-	P8_5	UD[6]	P8_5	UD[6]
LCD_VD5	-	-	P8_6	UD[5]	P8_6	UD[5]
LCD_VD4	-	-	P8_7	UD[4]	P8_7	UD[4]
LCD_VD3	P4_2	UD[3]	P4_2	UD[3]	P4_2	UD[3]



The glitch filter rejects pulses of typical 12 ns width.

Fig 46. Standard I/O pin configuration with analog input

13.6 Reset pin configuration

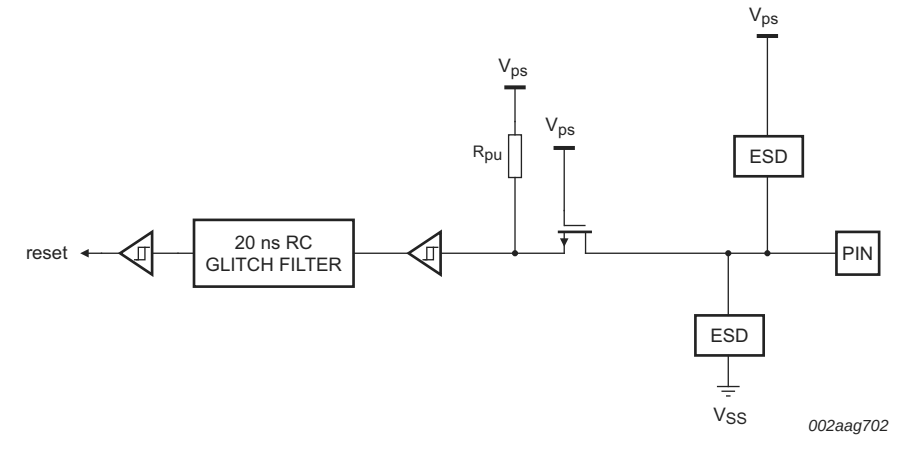


Fig 47. Reset pin configuration

13.7 Suggested USB interface solutions

The USB device can be connected to the USB as bus-powered device (see Figure 48) or self-powered device (see Figure 49).

On the LPC43S50/S30/S20, USBn_VBUS pins are 5 V tolerant only when VDDIO is applied and at operating voltage level. Therefore, if the USBn_VBUS function is connected to the USB connector and the device is self-powered, the USBn_VBUS pins must be protected for situations when VDDIO = 0 V.

If VDDIO is always at operating level while VBUS = 5 V, the USBn_VBUS pin can be connected directly to the VBUS pin on the USB connector.

For systems where VDDIO can be 0 V and VBUS is directly applied to the USBn_VBUS pins, precautions must be taken to reduce the voltage to below 3.6 V, which is the maximum allowable voltage on the USBn_VBUS pins in this case.

One method is to use a voltage divider to connect the USBn_VBUS pins to VBUS on the USB connector. The voltage divider ratio should be such that the USB_VBUS pin will be greater than 0.7VDDIO to indicate a logic HIGH while below the 3.6 V allowable maximum voltage.

For the following operating conditions

$VBUS_{max}$ = 5.25 V

VDDIO = 3.6 V,

the voltage divider should provide a reduction of 3.6 V/5.25 V or ~0.686.

For bus-powered devices, a regulator powered by USB can provide 3.3 V to VDDIO whenever bus power is present and ensure that power to the USBn_VBUS pins is always present when the 5 V VBUS signal is applied. See Figure 48. If the VBUS function of the USB1 interface is not connected, configure the pin function for GPIO using the function control bits in the SYSCON block.

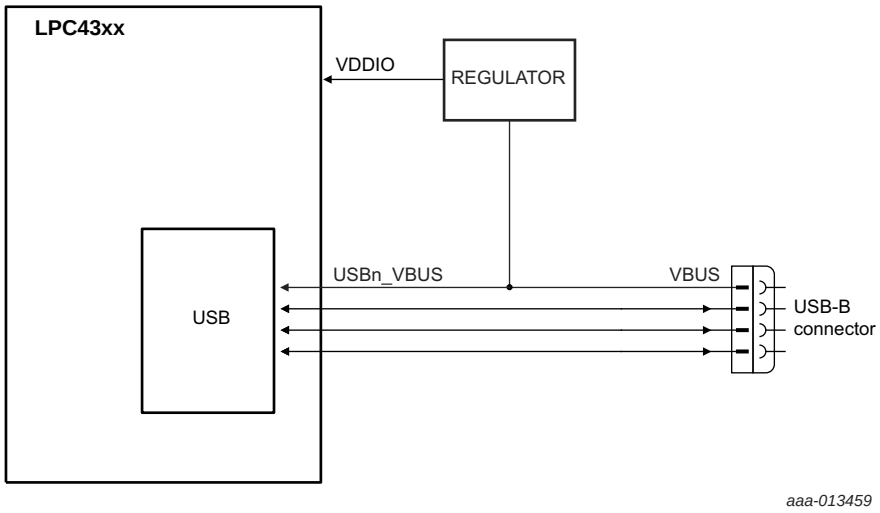
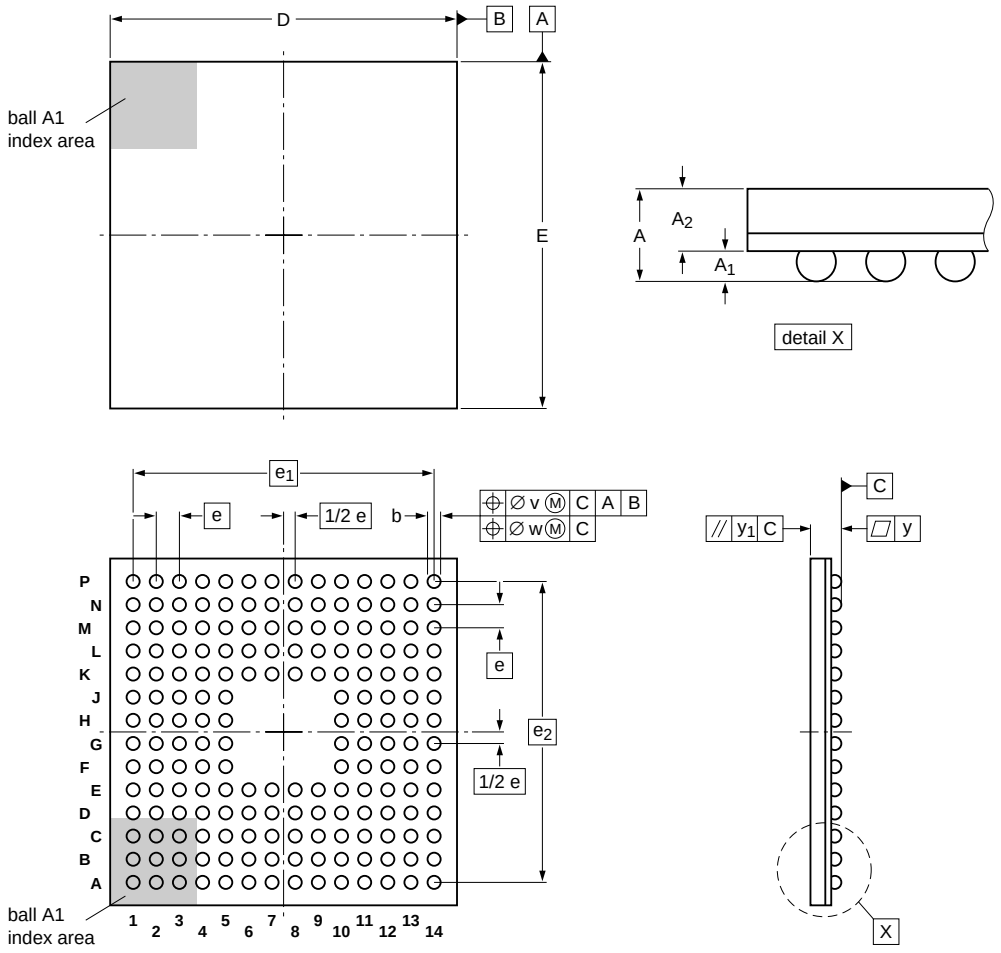


Fig 48. USB interface on a bus-powered device

TFBGA180: thin fine-pitch ball grid array package; 180 balls **SOT570-3**



DIMENSIONS (mm are the original dimensions)

UNIT		A	A_1	A_2	b	D	E	e	e_1	e_2	v	w	y	y_1
mm	max	1.20	0.40	0.80	0.50	12.1	12.1	0.8	10.4	10.4	0.15	0.05	0.12	0.1
	nom	1.06	0.35	0.71	0.45	12.0	12.0							
	min	0.95	0.30	0.65	0.40	11.9	11.9							

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT570-3						~~08-07-09~~ 10-04-15

Fig 52. Package outline of the TFBGA180 package